

N-Channel Power MOSFET

600V, 4A, 2.5Ω

FEATURES

- 100% Avalanche Tested
- Pb-free plating
- RoHS compliant
- Halogen-free according to IEC 61249-2-21

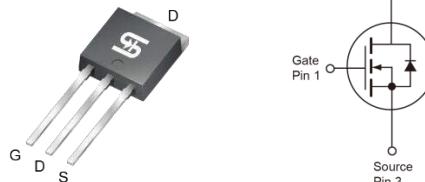
PRODUCT SUMMARY		
PARAMETER	VALUE	UNIT
V_{DS}	600	V
$R_{DS(on)}$ (max)	$V_{GS} = 10V$	2.5
Q_g	$V_{GS} = 10V$	16
		nC

APPLICATIONS

- Lighting
- Charger
- Power Supply
- Switching applications



TO-251 (IPAK)



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V_{DS}	600	V
Gate-Source Voltage	V_{GS}	± 30	V
Continuous Drain Current ^(Note 1)	I_D	4	A
$T_C = 100^\circ C$		2.7	
Pulsed Drain Current	I_{DM}	16	A
Single Pulse Avalanche Current ^(Note 2)	I_{AS}	4.6	A
Single Pulse Avalanche Energy ^(Note 2)	E_{AS}	84	mJ
Total Power Dissipation	P_D	114	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}	- 55 to +150	°C

THERMAL RESISTANCE

PARAMETER	SYMBOL	MAXIMUM	UNIT
Thermal Resistance – Junction to Case	R_{EJC}	1.1	°C/W
Thermal Resistance – Junction to Ambient	R_{EJA}	62	°C/W

Note: R_{EJA} is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins. R_{EJC} is guaranteed by design while R_{ECA} is determined by the user's board design

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ C$ unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Static						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	BV_{DSS}	600	--	--	V
Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250\mu A$	$V_{GS(TH)}$	2.5	2.8	4.5	V
Gate-Source Leakage Current	$V_{GS} = \pm 30V, V_{DS} = 0V$	I_{GSS}	--	--	± 100	nA
Drain-Source Leakage Current	$V_{GS} = 0V, V_{DS} = 600V$	I_{DSS}	--	--	1	μA
Drain-Source On-State Resistance <small>(Note 3)</small>	$V_{GS} = 10V, I_D = 2A$	$R_{DS(on)}$	--	2	2.5	Ω
Forward Transfer Conductance	$V_{DS} = 10V, I_D = 2A$	g_{fs}	--	4	--	S
Dynamic						
Total Gate Charge	$V_{GS} = 10V, V_{DS} = 480V, I_D = 4A$	Q_g	--	16	--	nC
Gate-Source Charge		Q_{gs}	--	2.6	--	
Gate-Drain Charge		Q_{gd}	--	7	--	
Input Capacitance	$V_{GS} = 0V, V_{DS} = 25V, f = 1.0MHz$	C_{iss}	--	574	--	pF
Output Capacitance		C_{oss}	--	56	--	
Reverse Transfer Capacitance		C_{rss}	--	7	--	
Switching <small>(Note 4)</small>						
Turn-On Delay Time	$V_{GS} = 10V, V_{DS} = 300V, I_D = 4A, R_G = 25\Omega$	$t_{d(on)}$	--	11	--	ns
Rise Time		t_r	--	14	--	
Turn-Off Delay Time		$t_{d(off)}$	--	38	--	
Fall Time		t_f	--	21	--	
Source-Drain Diode						
Diode Forward Voltage <small>(Note 3)</small>	$V_{GS} = 0V, I_S = 4A$	V_{SD}	--	--	1.13	V
Reverse Recovery Time	$V_{GS} = 10V, I_S = 2A$ $dI_F/dt = 100A/\mu s$	t_{rr}	--	188	--	ns
Reverse Recovery Charge		Q_{rr}	--	1.1	--	μC
Source Current <small>(Note 1)</small>	Integral reverse diode In the MOSFET	I_S	--	--	4	A
Source Current (Pulse)		I_{SM}	--	--	16	

Notes:

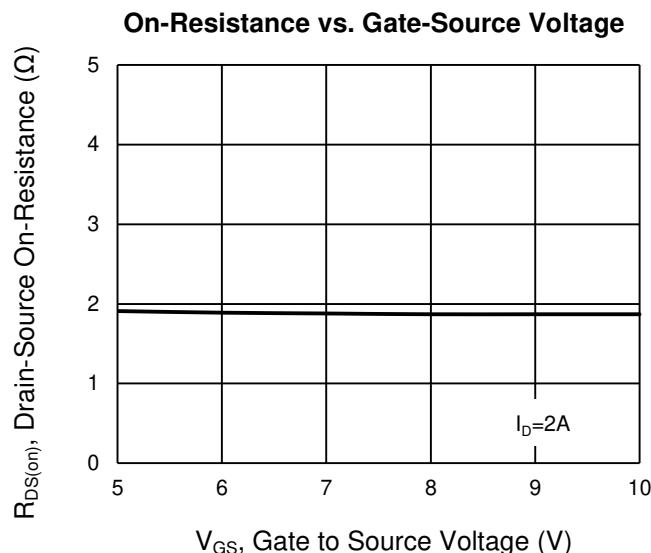
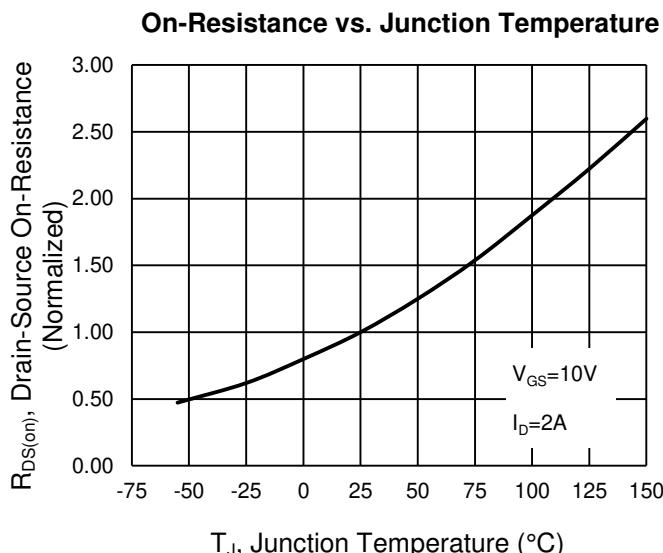
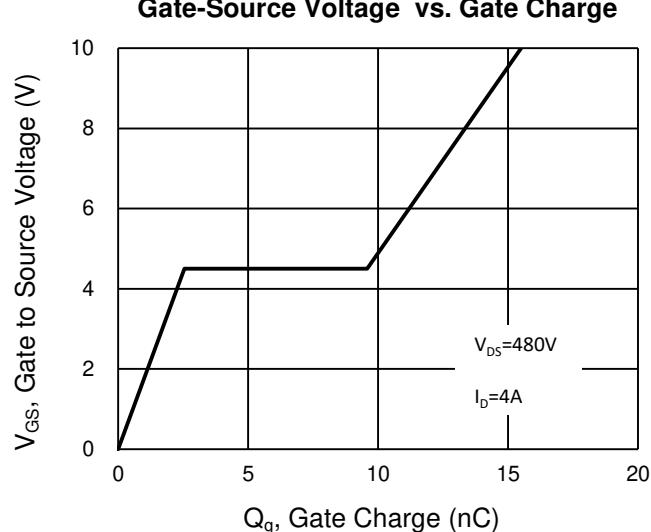
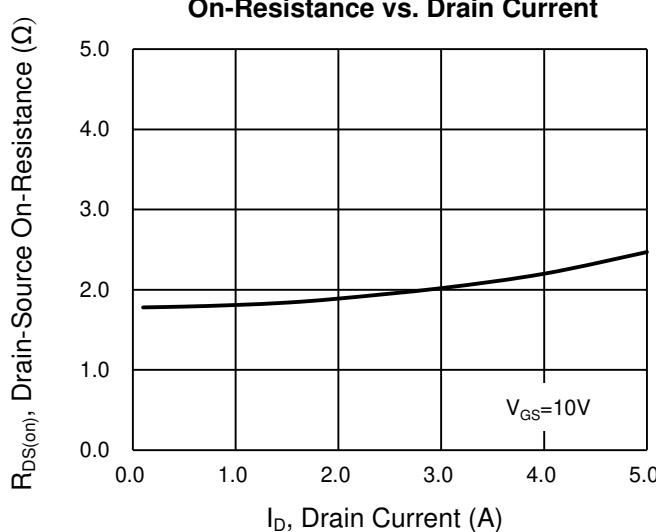
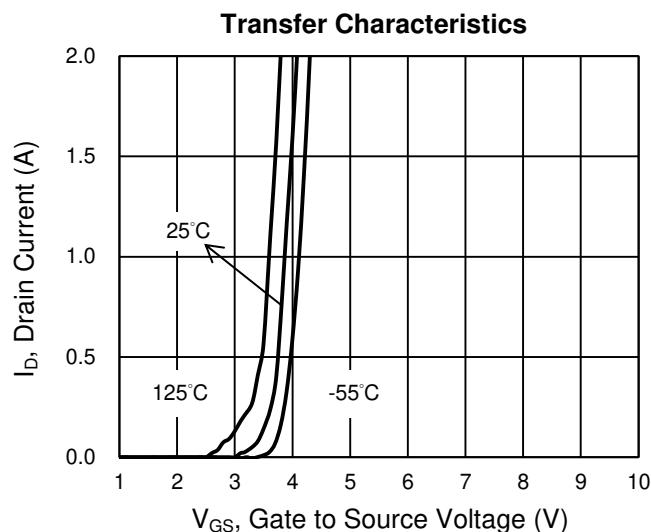
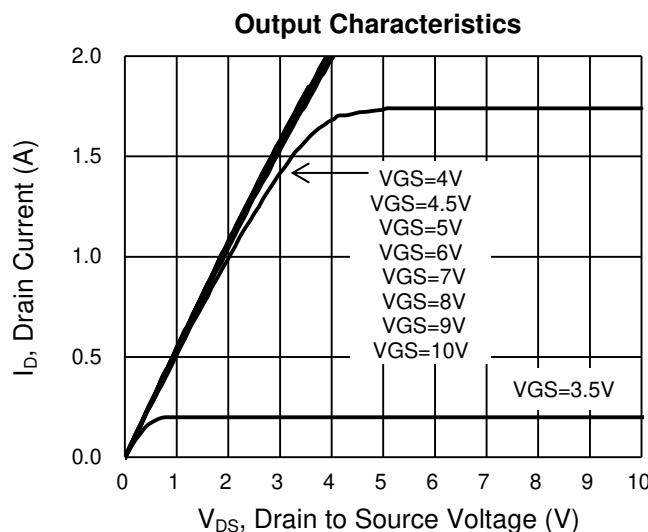
1. Pulsed width limited by maximum junction temperature.
2. $L = 8mH, V_{GS} = 10V, R_G = 25\Omega$, Starting $T_J = 25^\circ C$.
3. Pulse test: Pulse Width $\leq 300\mu s$, duty cycle $\leq 2\%$.
4. Switching time is essentially independent of operating temperature.

ORDERING INFORMATION

ORDERING CODE	PACKAGE	PACKING
TSM4NB60CH C5G	TO-251 (IPAK)	75 pcs / Tube

CHARACTERISTICS CURVES

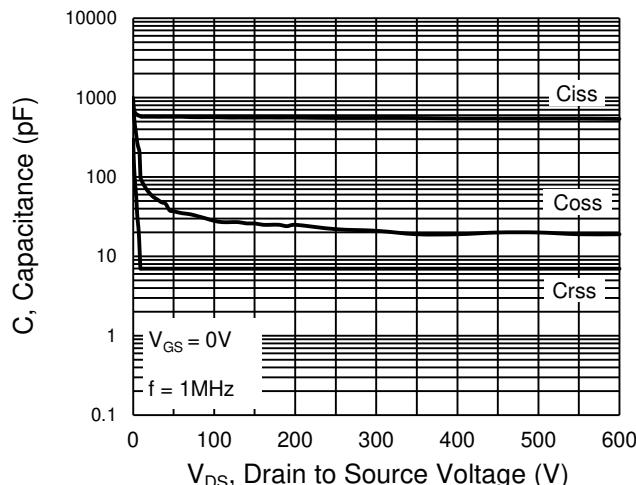
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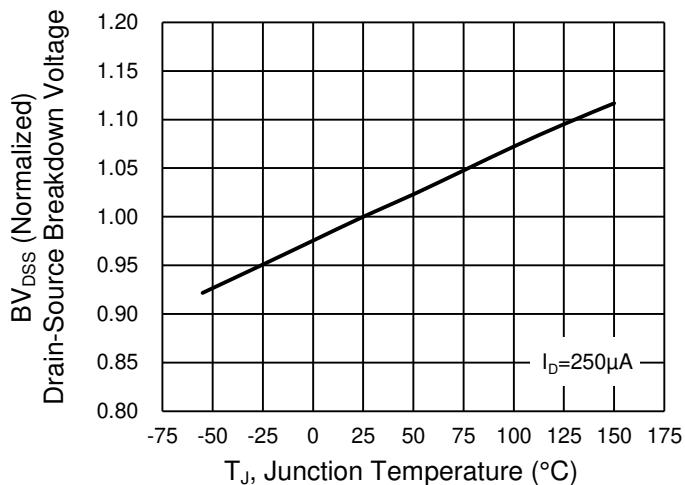
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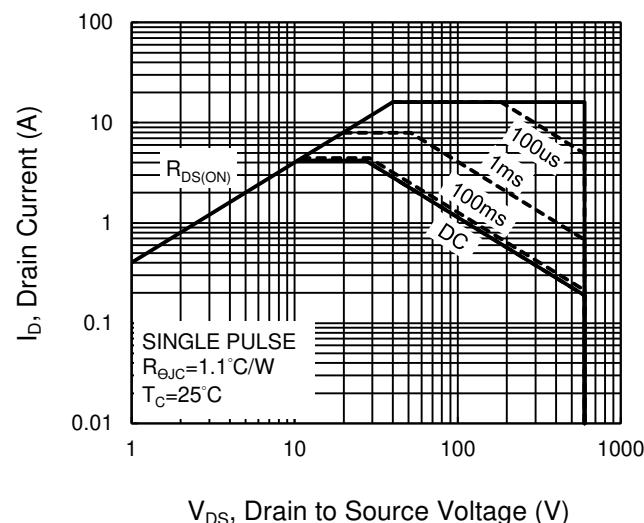
Capacitance vs. Drain-Source Voltage



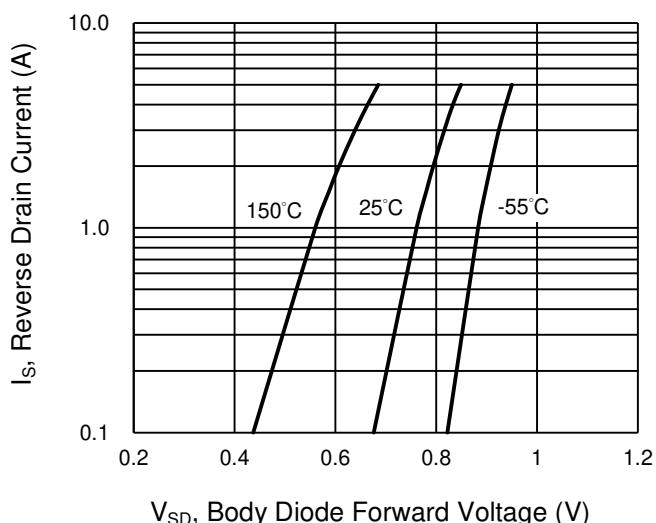
BV_{DSS} vs. Junction Temperature



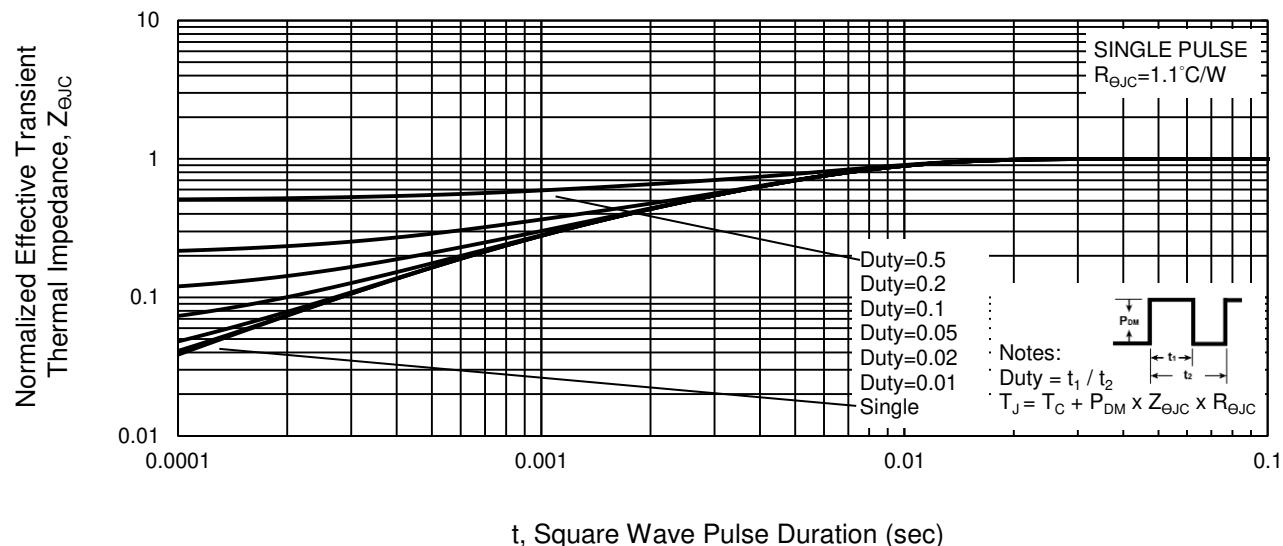
Maximum Safe Operating Area, Junction-to-Case



Source-Drain Diode Forward Current vs. Voltage

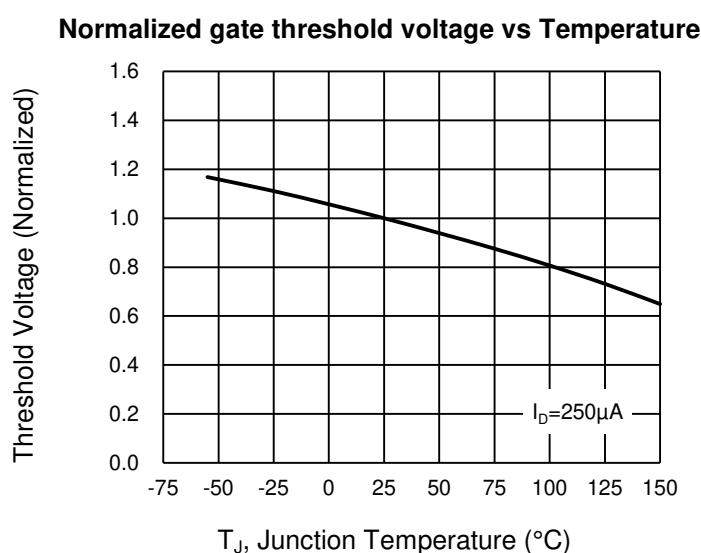
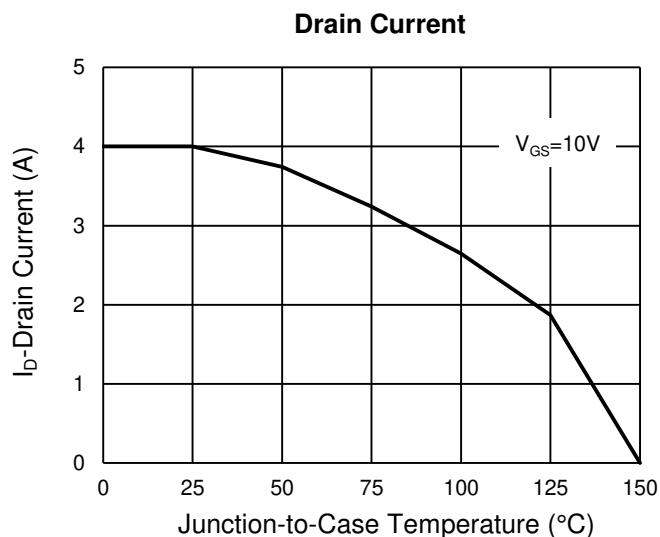
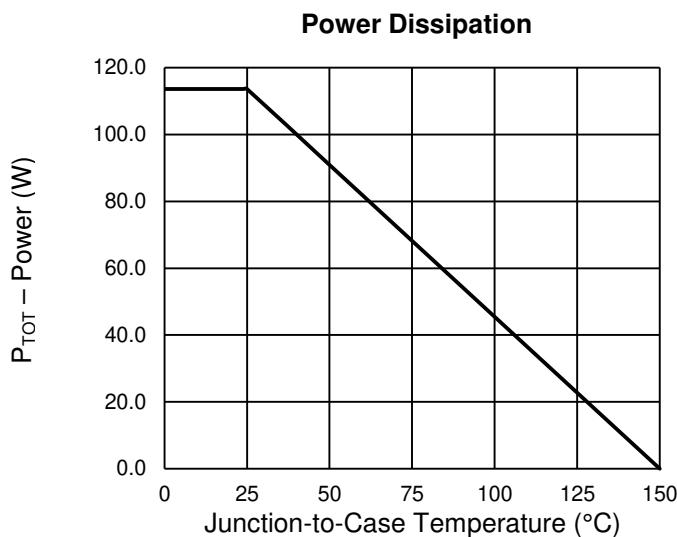


Normalized Thermal Transient Impedance, Junction-to-Case

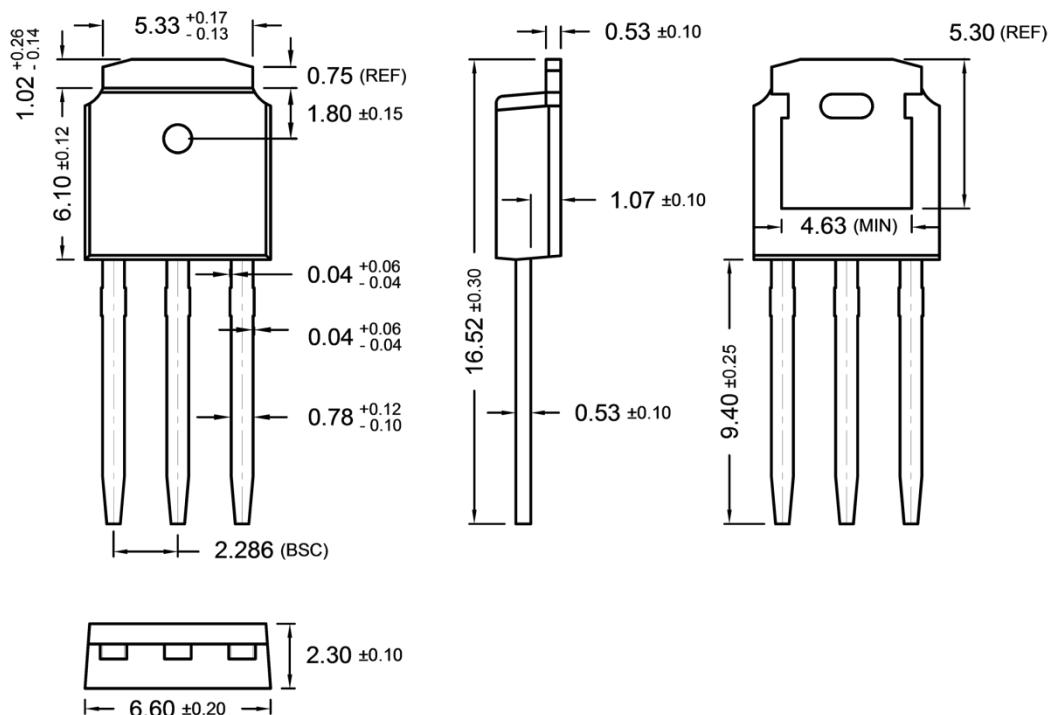
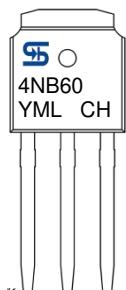


CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)



PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

TO-251 (IPAK)

MARKING DIAGRAM

Y = Year Code

M = Month Code

O =Jan **P** =Feb **Q** =Mar **R** =Apr

S =May **T** =Jun **U** =Jul **V** =Aug

W =Sep **X** =Oct **Y** =Nov **Z** =Dec

L = Lot Code (1~9, A~Z)

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